# The Network is Moving into the Socket

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## It Is Happening

- Integration of capabilities onto single silicon die and supporting chip sets is a natural progression of technology
- Motherboard integration is an intermediate step to chipset and then processor integration
- It is already happening -- Floating Point, Graphics, Memory controllers, PCIe, SATA/SAS, 1/10 GbE
- Embedded processor / mobile computing spaces are now leading the way

#### **There Are Good Reasons To Integrate**

- Economics
- Size
- Power
- Performance Close integration with the memory hierarchy is essential for high performance interconnects

## What About the Fabric?

- Represents the major opportunity for innovation
- Topologies will be richer
  - Driven by changing data center application requirements and need to scale
  - May need numerous fabric links
    - Reduce chip IOs Silicon photonics integration permits extreme highbandwidth interconnects to directly use a narrow interface
  - Adaptive Routing / Scheduling
- Separate / integrated / <u>hybrid</u> ?
  - Locality aware
  - Different internal / external architectures for interoperability

### **Questions / Predictions**

- Will the on-chip network dramatically change the processor design?
  *Primarily, will affect integration with the "un-core".*
- 2. What will happen to the data center ? *Integration of high bandwidth adapters will drive change throughout the data center. Data Centers will move to richer topologies as they become economically attractive.*
- 3. What will happen to HPC? *We will see more systems with complete interconnect fabric integrated into the logical and physical system structure.*
- 4. Will the integration of the network on-socket generate a monopoly and kill the bio-diversity that allowed the existence of many small networking companies. *Network integration will disrupt today's networking data center eco-system.*